Onsemi

IGBT - Field Stop II NGTB40N65FL2WG

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Field Stop II Trench construction, and provides superior performance in demanding switching applications, offering both low on state voltage and minimal switching loss. The IGBT is well suited for UPS and solar applications. Incorporated into the device is a soft and fast co-packaged free wheeling diode with a low forward voltage.

Features

- Extremely Efficient Trench with Field Stop Technology
- $T_{Jmax} = 175^{\circ}C$
- Soft Fast Reverse Recovery Diode
- Optimized for High Speed Switching
- 5 µs Short–Circuit Capability
- These are Pb-Free Devices

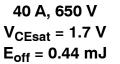
Typical Applications

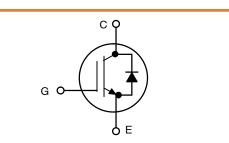
- Solar Inverters
- Uninterruptible Power Supplies (UPS)
- Welding

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-emitter Voltage	V _{CES}	650	V
Collector Current @ $T_C = 25^{\circ}C$ @ $T_C = 100^{\circ}C$	Ι _C	80 40	A
Diode Forward Current @ T _C = 25°C @ T _C = 100°C	I _F	80 40	A
Diode Pulsed Current T_{PULSE} Limited by T_J Max	I _{FM}	160	A
Pulsed Collector Current, T _{pulse} Limited by T _{Jmax}	I _{CM}	160	A
Short–circuit Withstand Time V _{GE} = 15 V, V _{CE} = 400 V, T _J \leq +150°C	t _{SC}	5	μs
Gate-emitter Voltage	V _{GE}	±20	V
Transient Gate-emitter Voltage (T _{PULSE} = 5 μs, D < 0.10)		±30	V
Power Dissipation @ $T_C = 25^{\circ}C$ @ $T_C = 100^{\circ}C$	P _D	366 183	W
Operating Junction Temperature Range	TJ	–55 to +175	°C
Storage Temperature Range	T _{stg}	–55 to +175	°C
Lead temperature for soldering, 1/8" from case for 5 seconds	T _{SLD}	260	°C

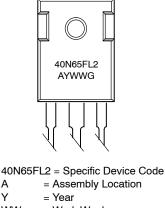
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.







MARKING DIAGRAM



WW = Work Week G

Α Υ

= Pb-Free Package

ORDERING INFORMATION

Device	Package	Shipping
NGTB40N65FL2WG	TO–247 (Pb–Free)	30 Units / Rail

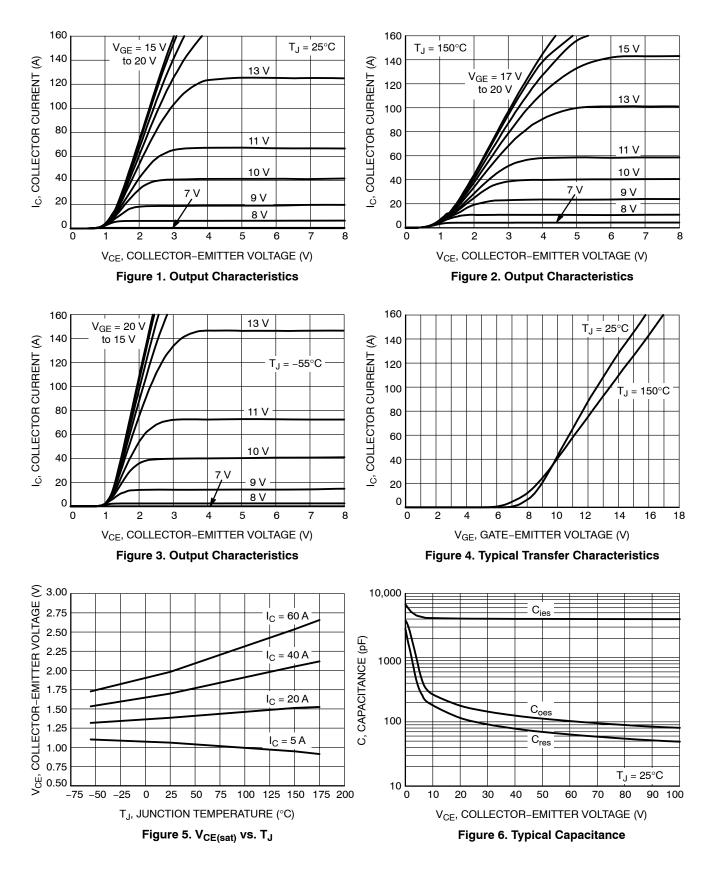
THERMAL CHARACTERISTICS

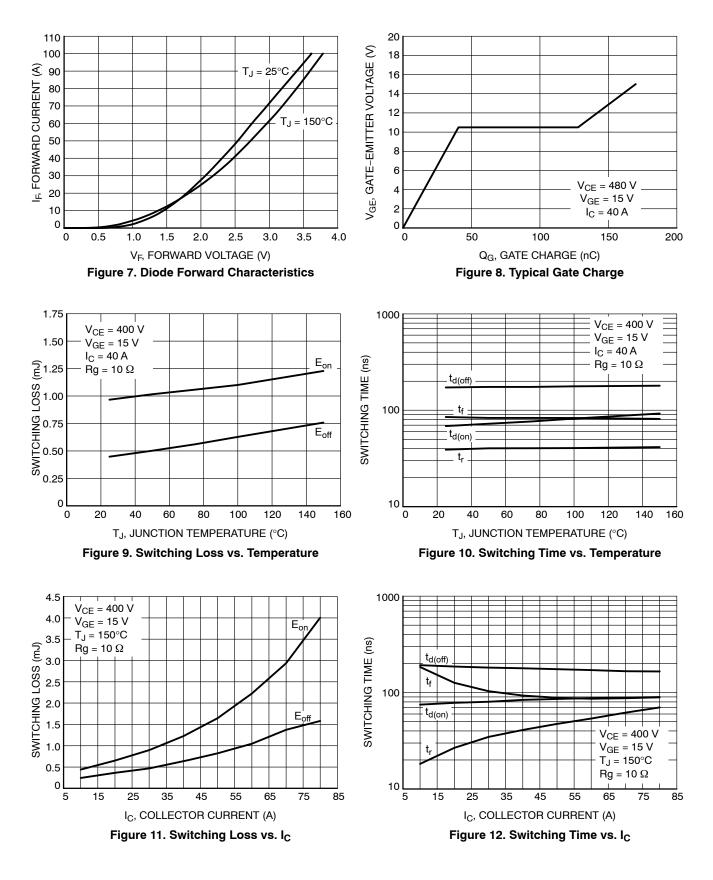
Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{ ext{ heta}JC}$	0.41	°C/W
Thermal resistance junction-to-case, for Diode	$R_{ ext{ heta}JC}$	1.00	°C/W
Thermal resistance junction-to-ambient	$R_{\theta JA}$	40	°C/W

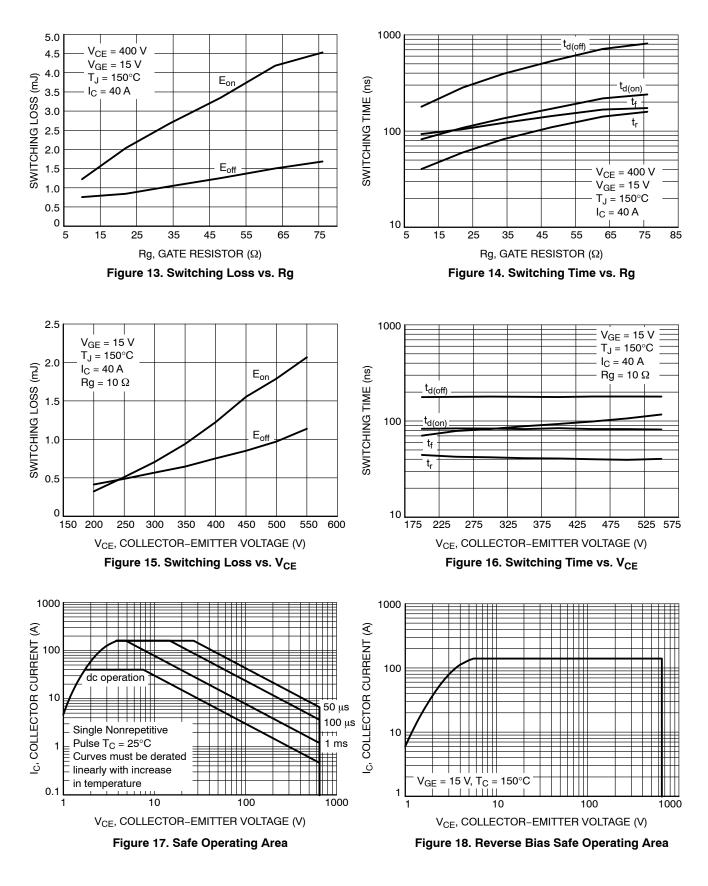
ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

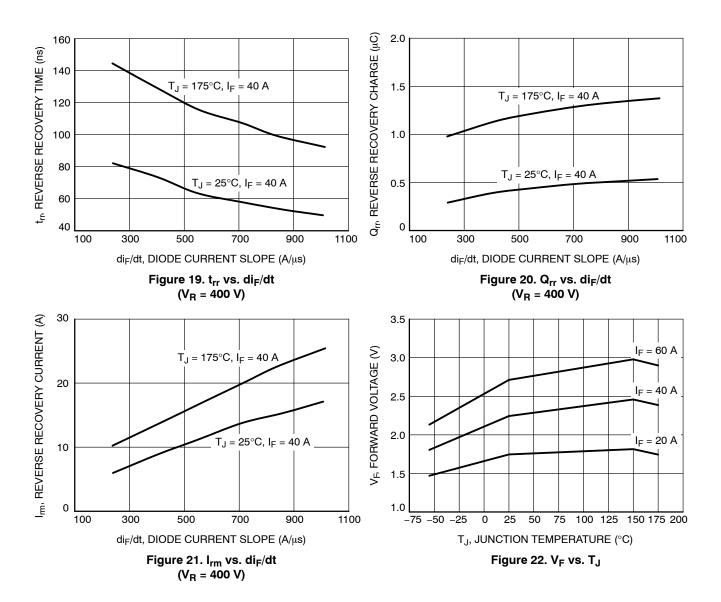
Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
STATIC CHARACTERISTIC						
Collector-emitter breakdown voltage, gate-emitter short-circuited	V_{GE} = 0 V, I _C = 500 μ A	V _{(BR)CES}	650	-	_	V
Collector-emitter saturation voltage	V_{GE} = 15 V, I _C = 40 A V_{GE} = 15 V, I _C = 40 A, T _J = 175°C	V _{CEsat}	1.50 -	1.70 2.10	2.00	V
Gate-emitter threshold voltage	$V_{GE} = V_{CE}, I_C = 350 \ \mu A$	V _{GE(th)}	4.5	5.5	6.5	V
Collector-emitter cut-off current, gate- emitter short-circuited	$V_{GE} = 0 V, V_{CE} = 650 V$ $V_{GE} = 0 V, V_{CE} = 650 V, T_{J =} 175^{\circ}C$	ICES	-		0.5 7.0	mA
Gate leakage current, collector-emitter short-circuited	V_{GE} = 20 V , V_{CE} = 0 V	I _{GES}	-	-	200	nA
DYNAMIC CHARACTERISTIC	·					-
Input capacitance		C _{ies}	-	4060	-	pF
Output capacitance	V_{CE} = 20 V, V_{GE} = 0 V, f = 1 MHz	C _{oes}	-	179	-	
Reverse transfer capacitance	1	C _{res}	-	115	-	
Gate charge total		Qg	-	170	-	nC
Gate to emitter charge	V_{CE} = 480 V, I _C = 40 A, V _{GE} = 15 V	Q _{ge}	-	41	-	
Gate to collector charge	1	Q _{gc}	-	87	-	
SWITCHING CHARACTERISTIC, INDUC	TIVE LOAD					
Turn-on delay time		t _{d(on)}	-	84	-	ns
Rise time	1	t _r	-	40	-	
Turn-off delay time	$T_{\rm J} = 25^{\circ} \rm C$	t _{d(off)}	-	177	-	
Fall time	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 40 \text{ A}$ $\text{R}_{g} = 10 \Omega$	t _f	-	70	-	
Turn-on switching loss	$V_{GE} = 0 V/15 V$	Eon	-	0.97	-	mJ
Turn-off switching loss	1	E _{off}	-	0.44	-	
Total switching loss	1	E _{ts}	-	1.41	-	
Turn-on delay time		t _{d(on)}	-	82	-	ns
Rise time	1	t _r	-	40	-	
Turn-off delay time	T _J = 150°C	t _{d(off)}	-	183	-	
Fall time	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 40 \text{ A}$ $R_{g} = 10 \Omega$	t _f	-	93	-	
Turn-on switching loss	V _{GE} = 0 V/ 15 V	E _{on}	-	1.20	-	mJ
Turn-off switching loss]	E _{off}	-	0.76	-	
Total switching loss		E _{ts}	-	1.96	-	
DIODE CHARACTERISTIC						
Forward voltage	V_{GE} = 0 V, I _F = 40 A V_{GE} = 0 V, I _F = 40 A, T _J = 175°C	V _F	1.50 -	2.20 2.40	2.90 -	V
Reverse recovery time	T _J = 25°C	t _{rr}	-	72	-	ns
Reverse recovery charge	I _F = 40 Å, V _R = 200 V	Q _{rr}	-	275	-	nC
Reverse recovery current	di _F /dt = 200 A/µs	I _{rrm}	-	6.7	-	Α
Reverse recovery time	T,₁ = 175°C	t _{rr}	-	158	-	ns
Reverse recovery charge	I _F = 40 Å, V _R = 400 V	Q _{rr}	-	980	-	nC
Reverse recovery current	di _F /dt = 200 A/µs	I _{rrm}	-	8.5	-	А

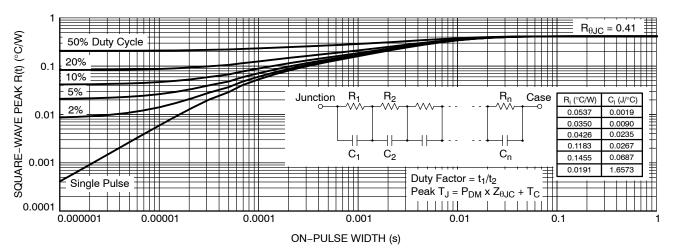
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

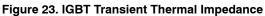












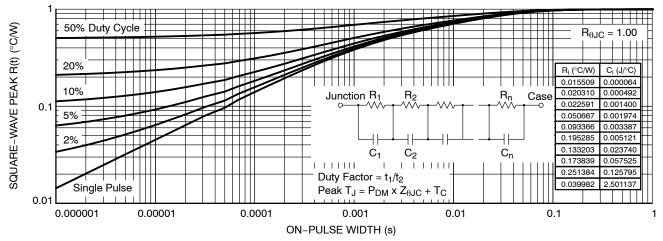


Figure 24. Diode Transient Thermal Impedance

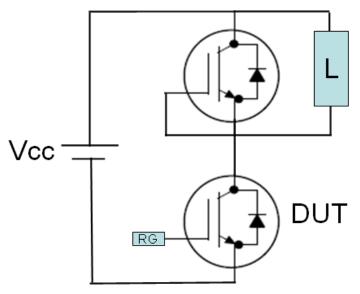
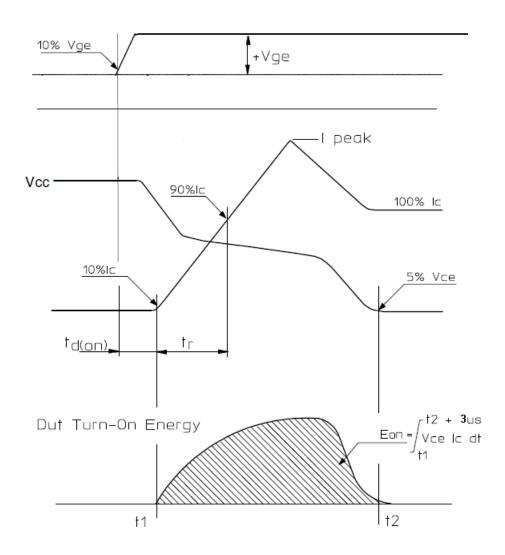
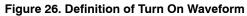


Figure 25. Test Circuit for Switching Characteristics





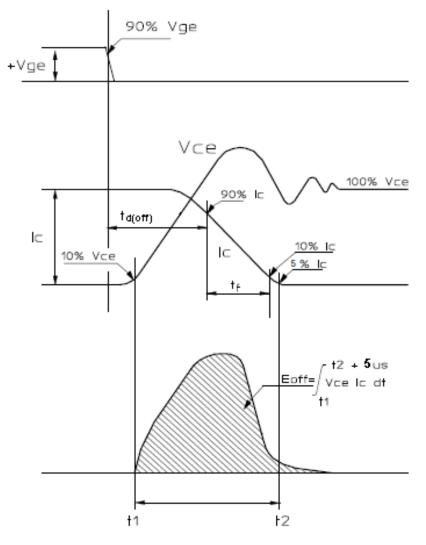
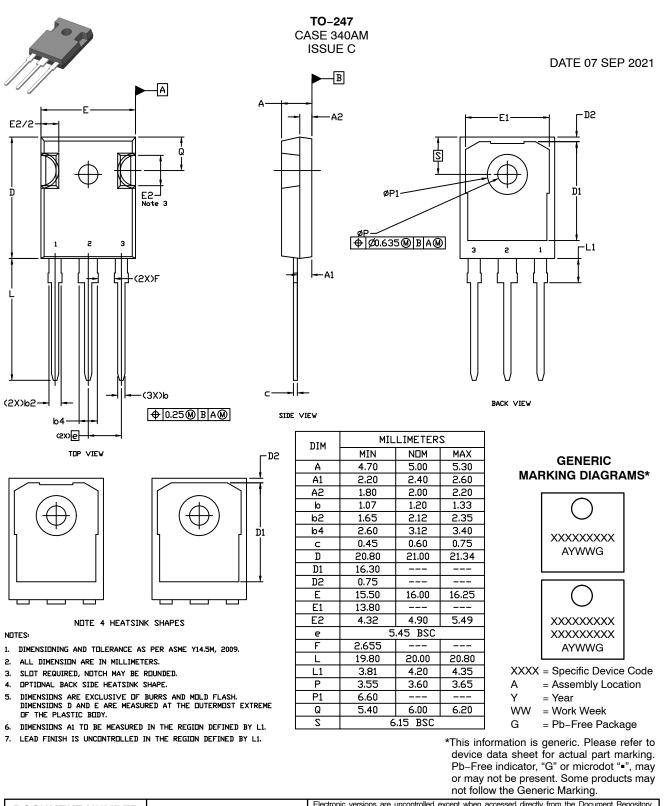


Figure 27. Definition of Turn Off Waveform





DOCUMENT NUMBER:	98AON77284F	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
DESCRIPTION:	TO-247		PAGE 1 OF 1	

ON Semiconductor and use trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and calcular performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

TECHNICAL SUPPORT

onsemi Website: www.onsemi.com

Email Requests to: orderlit@onsemi.com

North American Technical Support: Voice Mail: 1 800-282-9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support: Phone: 00421 33 790 2910 For additional information, please contact your local Sales Representative